Order Code - 33507A, 33507B, 33507C I.C. Bread Board Systems have been designed to provide instant circuit construction without soldering on the bread board area .Learners can insert components directly on breadboard and make all interconnections as required with 24 Swg (Gauge) solid wire. Within few minutes they can complete their projects/design on the same.

Your precious IC's are not damaged & are instantly reusable, No expensive special jumpers are required. You can insert all components directly without any adapters i.e. IC's such as types 8, 14, 16, 20 or 40 pin DIP units, LSI's and all discrete components with lead diameter upto 0.56mm (24 Swg).

S.No. ORDER CODE CONFIGURATION

01	33507A	Two full terminal strips, Tie points 1280, One distribution strip, Tie points 100, (total of 1380 tie/contact points) and two terminals (Binding Posts)
02	33507B	Two full terminal strips, Tie points 1280, Three distribution strips, Tie points 300 (total of 1580 tie/contact points) and three terminals (Binding Posts)
03	33507C	Two full terminal strips, Tie points 1280, Four Distribution strips, Tie points 400 (total of 1680 tie/contact points) and three terminals (Binding Posts).

POWER REQUIREMENT : 230V±10% at 50 Hz A.C. Mains

Strongly supported by detailed Operating Instructions.

Note: Specifications are subject to change.

Tesca Technologies Pvt. Ltd.

IT-2013, Ramchandrapura Industrial Area, Sitapura Extension,
Near Bombay Hospital, Vidhani Circle, Jaipur-302022, Rajasthan, India,
Tel: +91-141-2771791 / 2771792; Email: info@tesca.in, tesca.technologies@gmail.com
Website: www.tesca.in